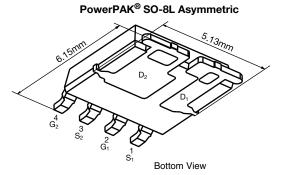


Vishay Siliconix

Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFETs

PRODUCT SUMMARY	ODUCT SUMMARY				
	N-CHANNEL 1	N-CHANNEL 2			
V _{DS} (V)	40	40			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.022	0.011			
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.026	0.013			
I _D (A)	15	45			
Configuration	Dual N				

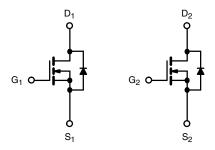


FEATURES

- TrenchFET[®] Power MOSFET
- AEC-Q101 Qualified^d
- 100 % R_a and UIS Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE



N-Channel 1 MOSFET

N-Channel 2 MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8L Dual Asymmetric
Lead (Pb)-free and Halogen-free	SQJ942EP-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, unless	otherwise r	noted)			
PARAMETER		SYMBOL	N-CHANNEL 1	N-CHANNEL 2	UNIT	
Drain-Source Voltage		V _{DS}	40	40	v	
Gate-Source Voltage		V _{GS}	± 20		v	
Continuous Drain Current ^a	T _C = 25 °C	1	15	45		
Continuous Drain Current-	T _C = 125 °C	I _D	15	32		
Continuous Source Current (Diode Conduction) ^a		IS	15	44	А	
Pulsed Drain Current ^b		I _{DM}	60	180		
Single Pulse Avalanche Current			19	27		
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	18.5	36.5	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	р	17	48	14/	
Maximum Power Dissipation?	T _C = 125 °C	P _D	6	16	W	
Operating Junction and Storage Temperature Ran	`		o + 175	℃		
Soldering Recommendations (Peak Temperature)	e, f		20	60		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	N-CHANNEL 1	N-CHANNEL 2	UNIT
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	75	70	°C/W
Junction-to-Case (Drain)		R _{thJC}	9	3.1	0/11

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR4 material).

d. Parametric verification ongoing.

e. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

S13-0708-Rev. B, 01-Apr-13

Document Number: 62669

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SQJ942EP

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PARAMETER	SYMBOL	TEST CONDITIONS				MIN. TYP.	MAX.	UNIT	
Static						I	1		
		V _{GS} =	N-Ch 1	40	-	-			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ N-		40	-	-		
	N	V _{DS} =	- V _{GS} , I _D = 250 μΑ	N-Ch 1	1.3	1.8	2.3	V	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	N-Ch 2	1.3	1.8	2.3		
Octo Octore Lockers			0.1/	N-Ch 1	-	-	± 100	~ ^	
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20$ V	N-Ch 2	-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} 40 V	N-Ch 1	-	-	1	+	
		$V_{GS} = 0 V$	V _{DS} = - 40 V	N-Ch 2	-	-	1		
Zaus Osta Valta na Dusia Osumant		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	N-Ch 1	-	-	50		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	N-Ch 2	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	N-Ch 1	-	-	150		
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	N-Ch 2	-	-	150		
		$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	N-Ch 1	30	-	-		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	N-Ch 2	30	-	-	A	
		V _{GS} = 10 V	I _D = 7.8 A	N-Ch 1	-	0.018	0.022		
		V _{GS} = 10 V	I _D = 10.1 A	N-Ch 2	-	0.009	0.011		
		V _{GS} = 10 V	I _D = 7.8 A, T _J = 125 °C	N-Ch 1	-	-	0.032	Ω	
	-	V _{GS} = 10 V	I _D = 10.1 A, T _J = 125 °C	N-Ch 2	-	-	0.017		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 7.8 A, T _J = 175 °C	N-Ch 1	-	-	0.038		
		V _{GS} = 10 V	I _D = 10.1 A, T _J = 175 °C	N-Ch 2	-	-	0.020		
		V _{GS} = 4.5 V	I _D = 7.1 A	N-Ch 1	-	0.022	0.026		
		V _{GS} = 4.5 V	I _D = 9.3 A	N-Ch 2	-	0.011	0.013		
		V _{DS} =	= 15 V, I _D = 7.8 A	N-Ch 1	-	46	-	1	
Forward Transconductance ^b	9 _{fs}	V _{DS} =	= 15 V, I _D = 10.1 A	N-Ch 2	-	73	-	S	
Dynamic ^b	<u> </u>					I	1		
		$V_{GS} = 0 V$	V _{DS} = 20 V, f = 1 MHz	N-Ch 1	-	647	809		
Input Capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 2	-	1161	1451		
		$V_{GS} = 0 V$	V _{DS} = 20 V, f = 1 MHz	N-Ch 1	-	105	131	- I	
Output Capacitance	C _{oss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch 2	-	178	222	pF	
	_	$V_{GS} = 0 V$	V _{DS} = 20 V, f = 1 MHz	N-Ch 1	-	42	53		
Reverse Transfer Capacitance	C _{rss}	$V_{GS} = 0 V$	V _{DS} = 20 V, f = 1 MHz	N-Ch 2	-	68	85		
		V _{GS} = 10 V	V _{DS} = 20 V, I _D = 16 A	N-Ch 1	-	13.1	19.7		
Lotal Gate Charge ^c () _a	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 6 A	N-Ch 2	-	22.5	33.8			
ate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 16 A	N-Ch 1	-	2.12	-	nC	
		V _{GS} = 10 V	V _{DS} = 20 V, I _D = 6 A	N-Ch 2	-	3.35	-	1	
		V _{GS} = 10 V	V _{DS} = 20 V, I _D = 16 A	N-Ch 1	-	1.84	-	1	
Gate-Drain Charge ^c	Q _{gd}	V _{GS} = 10 V	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 6 \text{ A}$	N-Ch 2	-	3.14	-	7	
	Rg			N-Ch 1	1.5	3.02	5		
Gate Resistance			N-Ch 2	2.05	4.11	7	Ω		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

2



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SPECIFICATIONS (T _C = 25	°C, unless o	otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Turn-On Delay Time ^c	+	$\begin{array}{l} V_{DD} = 20 \ V, \ R_{L} = 20 \ \Omega \\ I_{D} \cong 1 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \end{array}$	N-Ch 1	- 33 50				
	t _{d(on)}	$V_{DD} = 20 \text{ V}, \text{R}_{\text{L}} = 20 \Omega$ $\text{I}_{D} \cong 1 \text{A}, \text{V}_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$ N-Ch 2		-	40	60		
Rise Time ^c	+	$\begin{array}{l} V_{DD} = 20 \ V, \ R_{L} = 20 \ \Omega \\ I_{D} \cong 1 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \end{array}$	N-Ch 1	-	25	38		
Rise Time ²	t _r	$\begin{array}{l} V_{DD} = 20 \; V, \; R_{L} = 20 \; \Omega \\ I_{D} \cong 1 \; A, \; V_{GEN} = 10 \; V, \; R_{g} = 1 \; \Omega \end{array}$	N-Ch 2	2 - 31 46		46		
		$\begin{array}{l} V_{DD} = 20 \ V, \ R_{L} = 20 \ \Omega \\ I_{D} \cong 1 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \end{array}$	N-Ch 1	-	29	43	- ns	
Turn-Off Delay Time ^c	t _{d(off)}	$\begin{array}{l} V_{DD} = 20 \; V, \; R_{L} = 20 \; \Omega \\ I_{D} \cong 1 \; A, \; V_{GEN} = 10 \; V, \; R_{g} = 1 \; \Omega \end{array}$	N-Ch 2	h 1 - h 2 - h 1 - h	52	78		
Fall Time ^c	+	$\begin{array}{l} V_{DD} = 20 \ V, \ R_{L} = 20 \ \Omega \\ I_{D} \cong 1 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \end{array}$	N-Ch 1	-	12	18		
	t _f	$\label{eq:VDD} \begin{array}{l} V_{DD} = 20 \ V, \ R_{L} = 20 \ \Omega \\ I_{D} \cong 1 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \end{array}$	N-Ch 2	-	16	24		
Source-Drain Diode Ratings and Characteristics ^b								
Pulsed Current ^a	lau		N-Ch 1	_	-	60	A	
	I _{SM}		N-Ch 2	-	-	180		
Forward Voltage	Ver	I _S = 5.2 A	N-Ch 1	-	0.8	1.2	v	
l of ward voltage	V _{SD}	I _S = 6.8 A	N-Ch 2	-	0.8	1.2	v	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},~\text{duty}~\text{cycle} \leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

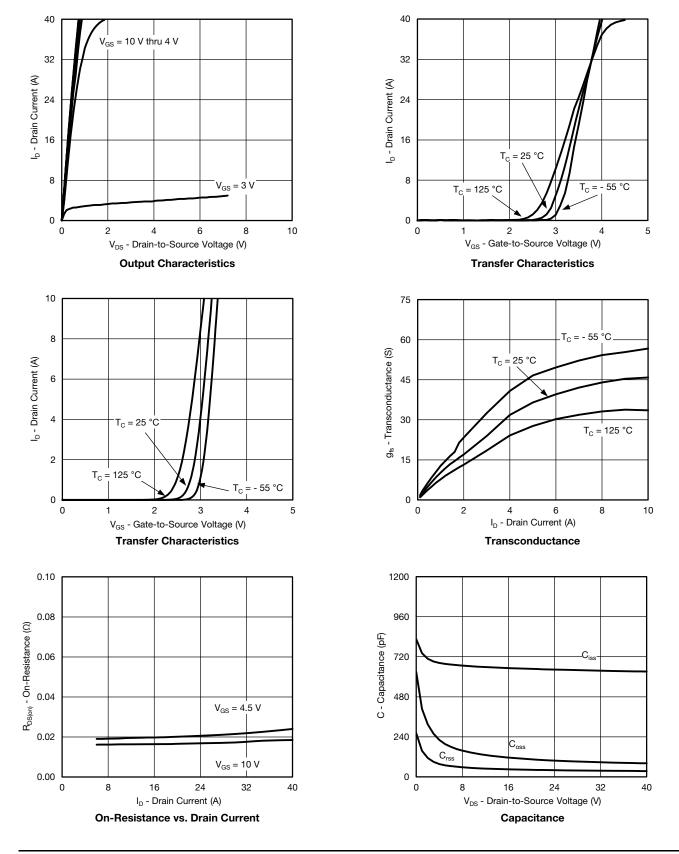
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



S13-0708-Rev. B, 01-Apr-13

4

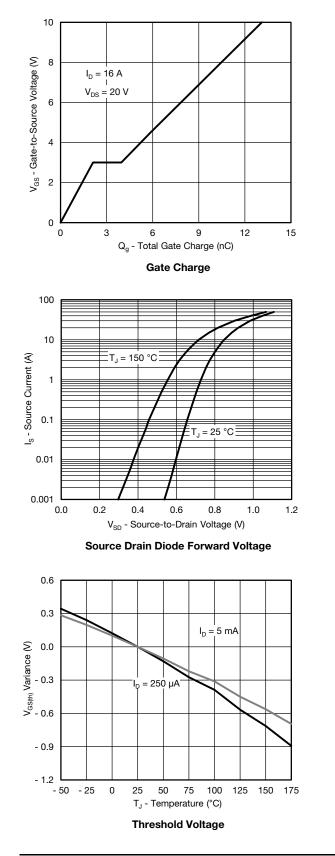
Document Number: 62669

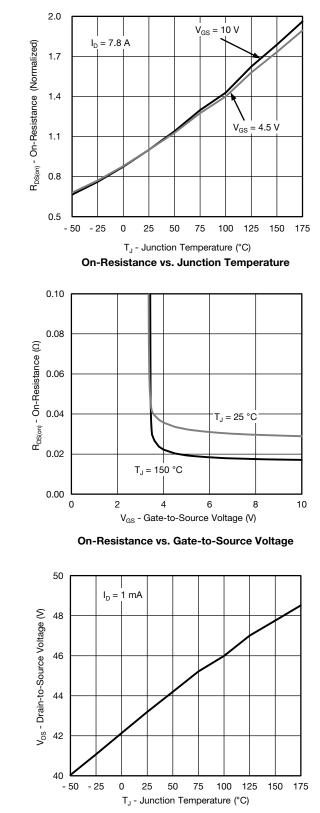
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N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Drain Source Breakdown vs. Junction Temperature

S13-0708-Rev. B, 01-Apr-13

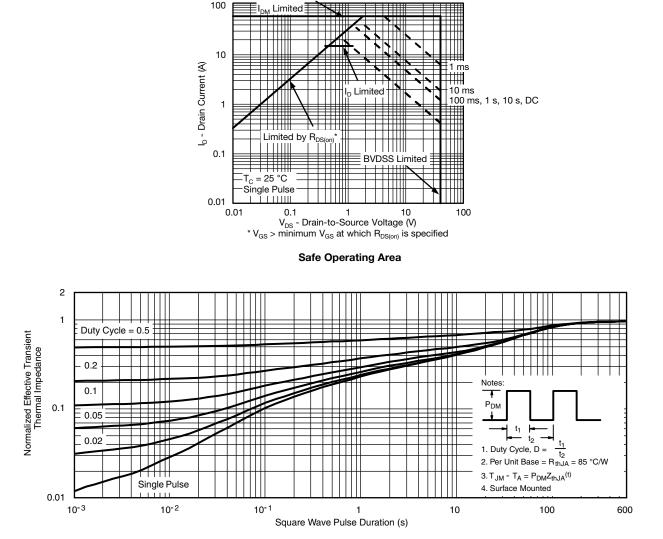
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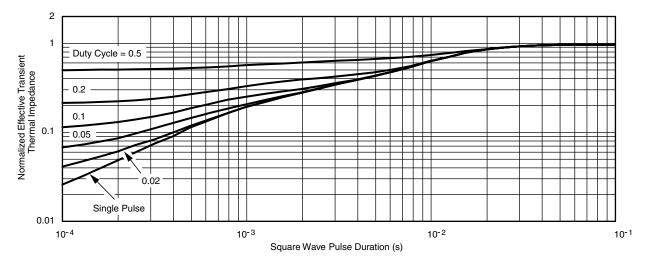
N-CHANNEL 1 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

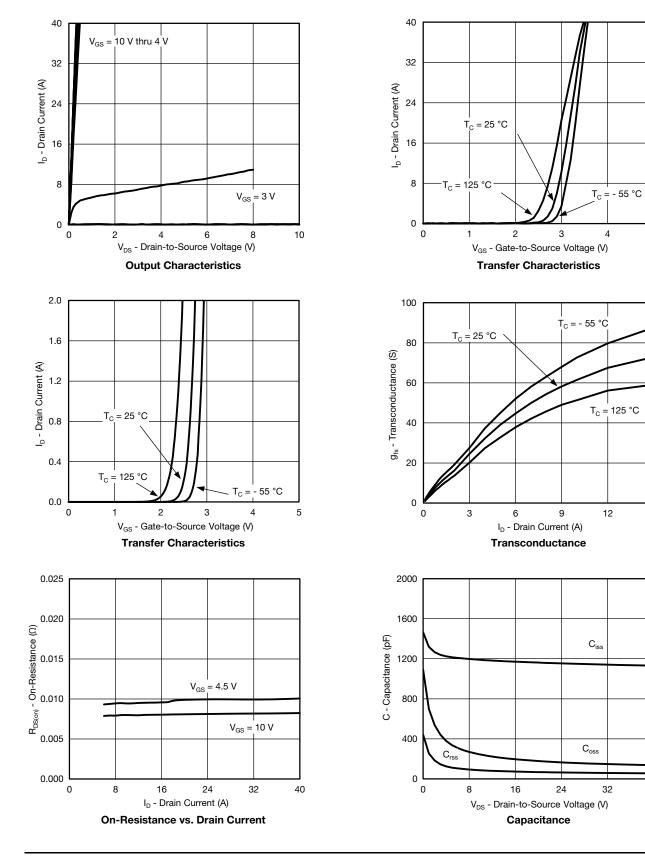


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N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



S13-0708-Rev. B, 01-Apr-13

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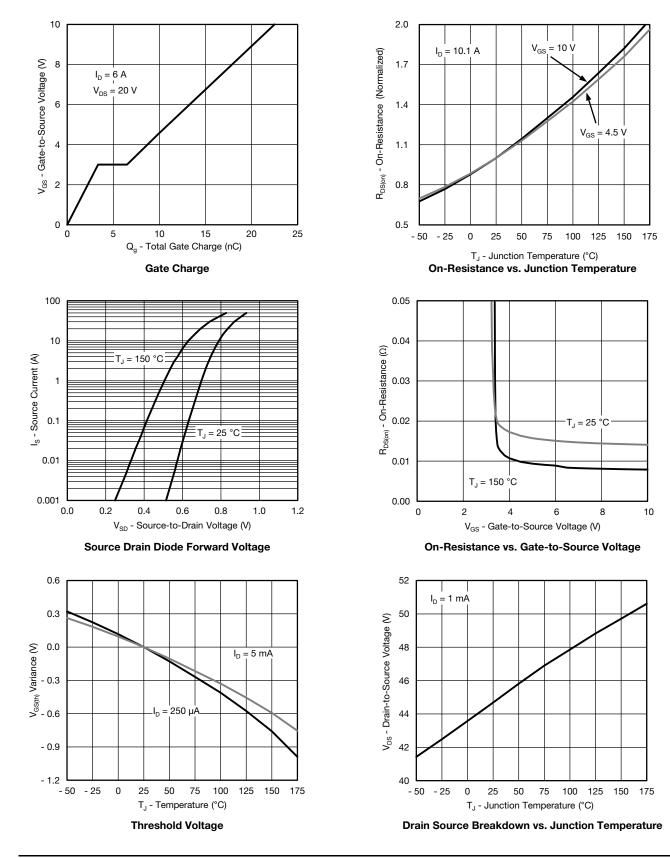
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N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



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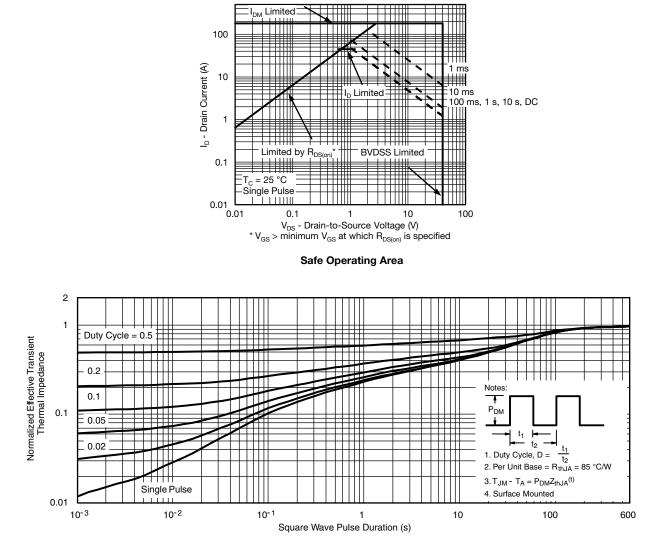
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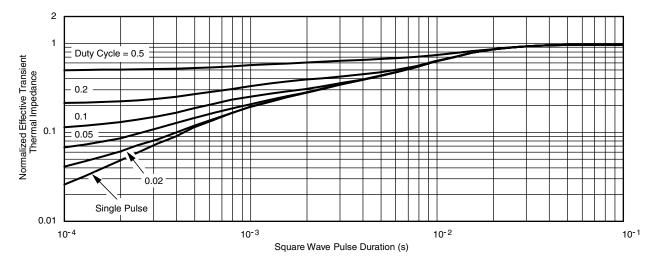
N-CHANNEL 2 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

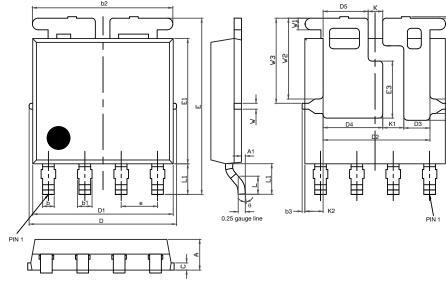
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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PowerPAK[®] SO-8L Assymetric Case Outline



DIM.		MILLIMETERS		INCHES			
DINI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	0.06	0.13	0.000	0.003	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3	0.04	0.12	0.20	0.002	0.005	0.008	
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.63	3.73	3.83	0.143	0.147	0.151	
D3	0.81	0.91	1.01	0.032	0.036	0.040	
D4	1.98	2.08	2.18	0.078	0.082	0.086	
D5	1.47	1.57	1.67	0.058	0.062	0.066	
е	1.20	1.27	1.34	0.047	0.050	0.053	
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
E3	1.89	1.99	2.09	0.074	0.078	0.082	
F	0.05	0.12	0.19	0.002	0.005	0.007	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К	0.41	0.51	0.61	0.016	0.020	0.024	
K1	0.64	0.74	0.84	0.025	0.029	0.033	
K2	0.54	0.64	0.74	0.021	0.025	0.029	
W	0.13	0.23	0.33	0.005	0.009	0.013	
W1	0.31	0.41	0.51	0.012	0.016	0.020	
W2	2.72	2.82	2.92	0.107	0.111	0.115	
W3	2.86	2.96	3.06	0.113	0.117	0.120	
W4	0.41	0.51	0.61	0.016	0.020	0.024	
θ	5°	10°	12°	5°	10°	12°	

DWG: 6009

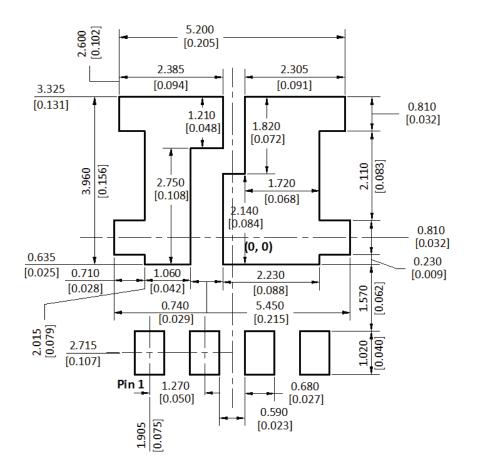
Note

• Millimeters will govern

C14-0057-Rev. D, 07-Apr-14



RECOMMENDED MINIMUM PADs FOR PowerPAK® SO-8L DUAL ASYMMETRIC



Recommended Minimum Pads Dimensions in mm [inches]



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